

15A, 35V - 150V Schottky Barrier Surface Mount Rectifier

FEATURES

- Low power loss, high efficiency
- Ideal for automated placement
- Guard ring for overvoltage protection
- · High surge current capability
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- Switching mode power supply (SMPS)
- Adapters
- DC to DC converters

MECHANICAL DATA

- Case: TO-263AB (D²PAK)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: As marked
- Weight: 1.37g (approximately)

KEY PARAMETERS						
PARAMETER	VALUE	UNIT				
I _F	15	Α				
V_{RRM}	35 - 150	V				
I _{FSM}	150	Α				
T _{J MAX}	150	°C				
Package	TO-263AB (D ² PAK)					
Configuration	Dual d	lies				

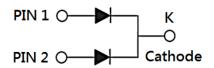








TO-263AB (D²PAK)



ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)									
		MBRS	MBRS	MBRS	MBRS	MBRS	MBRS	MBRS	
PARAMETER	SYMBOL	1535	1545	1550	1560	1590	15100	15150	UNIT
		CT	CT	CT	CT	CT	СТ	CT	
Marking code on the device		MBRS 1535CT	MBRS 1545CT	MBRS 1550CT	MBRS 1560CT	MBRS 1590CT	MBRS 15100CT	MBRS 15150CT	
Repetitive peak reverse voltage	V_{RRM}	35	45	50	60	90	100	150	V
Reverse voltage, total rms value	$V_{R(RMS)}$	24	31	35	42	63	70	105	V
Forward current	I _F				15				Α
Surge peak forward current, 8.3ms single half sine wave superimposed on rated load	I _{FSM}	150							А
Peak repetitive reverse surge current ⁽¹⁾	I _{RRM}	1 0.5						Α	
Peak repetitive forward current (Rated V _R , Square wave, 20KHz)	I _{FRM}	15					А		
Critical rate of rise of off- state voltage	dv/dt				10,000				V/µs

Notes:

1. $tp = 2.0\mu s$, 1.0KHz



ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)									
PARAMETER	SYMBOL	MBRS 1535 CT	MBRS 1545 CT	MBRS 1550 CT	MBRS 1560 CT	MBRS 1590 CT	MBRS 15100 CT	MBRS 15150 CT	UNIT
Junction temperature	T_J	-55 to +150					°C		
Storage temperature	T _{STG}				-55 to +1	50			°C

THERMAL PERFORMANCE							
PARAMETER	SYMBOL	TYP	UNIT				
Junction-to-ambient thermal resistance	$R_{\Theta JA}$	50	°C/W				
Junction-to-case thermal resistance	R _{eJC}	2	°C/W				

PARAMETER		CONDITIONS	SYMBOL	TYP	MAX	UNIT
	MBRS1535CT MBRS1545CT			-	-	V
	MBRS1550CT MBRS1560CT	I _F = 7.5A, T _{.I} = 25°C		-	0.75	V
	MBRS1590CT MBRS15100CT	1; = 7.571, 1j = 25 G		-	0.92	V
	MBRS15150CT			-	0.95	V
	MBRS1535CT MBRS1545CT			-	0.84	V
	MBRS1550CT MBRS1560CT	I _F = 15.0A, T _J = 25°C		-	-	V
	MBRS1590CT MBRS15100CT	,		-	-	V
Forward voltage per diode ⁽¹⁾	MBRS15150CT		- V _F	-	-	V
diode ⁽¹⁾	MBRS1535CT MBRS1545CT	I _F = 7.5A, T _J = 125°C	VF	-	0.57	V
	MBRS1550CT MBRS1560CT			-	0.65	V
	MBRS1590CT MBRS15100CT			-	0.82	V
	MBRS15150CT			-	0.92	V
	MBRS1535CT MBRS1545CT	I _F = 15.0A, T _J = 125°C		-	0.72	V
	MBRS1550CT MBRS1560CT			-	-	V
	MBRS1590CT MBRS15100CT			-	-	V
	MBRS15150CT			-	-	V



ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)						
PARAMETER		CONDITIONS	SYMBOL	TYP	MAX	UNIT
Reverse current @ rated V_R	MBRS1535CT MBRS1545CT MBRS1550CT MBRS1560CT MBRS1590CT MBRS15100CT MBRS15150CT	T _J = 25°C	-	1	100	μА
per diode ⁽²⁾	MBRS1535CT MBRS1545CT		I _R	-	15	mA
	MBRS1550CT MBRS1560CT	T _J = 125°C		1	10	mA
	MBRS1590CT MBRS15100CT MBRS15150CT			-	5	mA

Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION		
ORDERING CODE ⁽¹⁾	PACKAGE	PACKING
MBRS15xCT	TO-263AB (D ² PAK)	800 / Tape & Reel

Notes:

1. "x" defines voltage from 35V(MBRS1535CT) to 150V(MBRS15150CT)

Fig.2 Typical Junction Capacitance



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.1 Forward Current Derating Curve

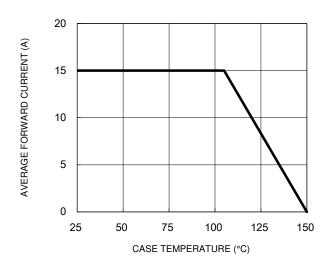


Fig.3 Typical Reverse Characteristics

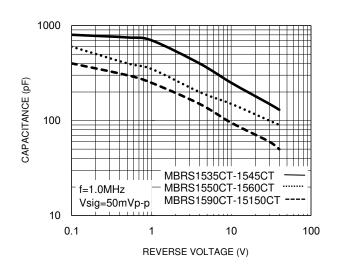
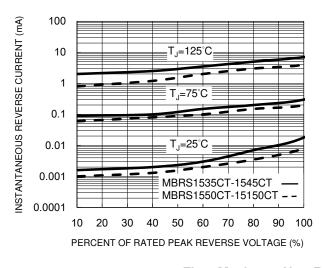


Fig.4 Typical Forward Characteristics



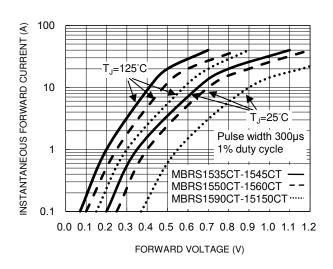
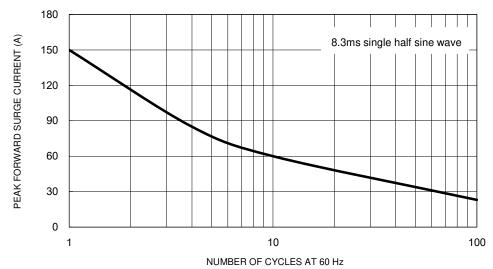


Fig.5 Maximum Non-Repetitive Forward Surge Current



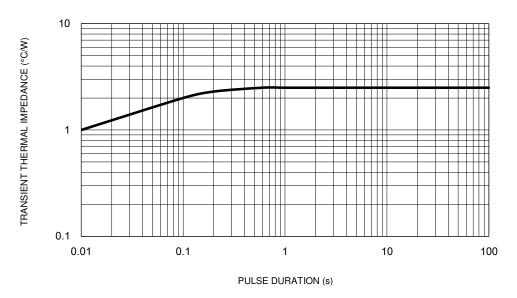
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CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.6 Typical Transient Thermal Impedance

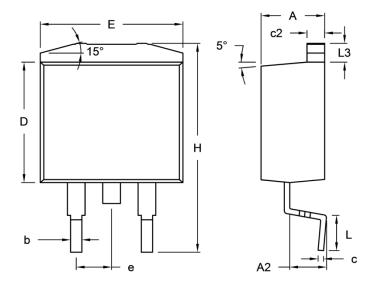






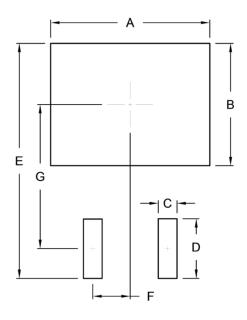
PACKAGE OUTLINE DIMENSIONS

TO-263AB (D²PAK)



DIM.	Unit	(mm)	Unit ((inch)	
DIN.	Min.	Max.	Min.	Max.	
Α	4.44	4.70	0.175	0.185	
A2	2.03	2.79	0.080	0.110	
b	0.68	0.94	0.027	0.037	
С	0.36	0.53	0.014	0.021	
c2	1.14	1.40	0.045	0.055	
D	8.25	9.25	0.325	0.364	
E	-	10.50	-	0.413	
е	2.41	2.67	0.095	0.105	
Н	14.60	15.88	0.575	0.625	
L	2.29	2.79	0.090	0.110	
L3	1.14	1.40	0.045	0.055	

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
Α	10.80	0.425
В	8.30	0.327
С	1.27	0.050
D	4.05	0.159
E	15.95	0.628
F	2.54	0.100
G	9.775	0.385

MARKING DIAGRAM



P/N = Marking Code G = Green Compound

YWW = Date Code = Factory Code



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